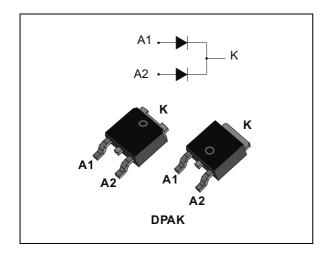


STPS15L60C

Power Schottky rectifier

Datasheet - production data



Features

- Very small conduction losses
- Negligible switching losses
- Low forward voltage drop
- Avalanche specification
- ECOPACK[®]2 compliant component for DPAK on demand

Description

Dual center tab Schottky rectifier suited for switched mode power supply and high frequency DC to DC converters.

Packaged in DPAK, this device is intended for use in low voltage, high frequency inverters, freewheeling and polarity protection applications.

Value
2 x 7.5 A
60 V
150 °C
0.52 V

This is information on a product in full production.

1 Characteristics

Table 2. Absolute ratings (limiting values per diode at 25 °C unless otherwise stated)

Symbol	Parameter	Value	Unit		
V _{RRM}	Repetitive peak reverse voltage			60	V
I _{F(RMS)}	Forward rms current			10	А
1	Average forward current, $\delta = 0.5$, square T = 125 %		Per diode	7.5	А
IF(AV)	wave	$T_{c} = 135 \ ^{\circ}C^{(1)}$	Per device	15	A
I _{FSM}	Surge non repetitive forward current t _p = 10 ms sinusoidal			75	А
P _{ARM}	Repetitive peak avalanche power $t_p = 10 \ \mu s, T_j = 125 \ ^{\circ}C$			265	W
T _{stg}	Storage temperature range	-65 to +175	°C		
Тj	Maximum operating junction temperature ⁽²	150	°C		

1. Value based on $R_{th(j-c)}$ max (per diode)

2. $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Symbol	Parameter	Value	Unit	
P	Junction to case	Per diode	4	
R _{th(j-c)}		Total	2.4	°C/W
R _{th(c)}	Coupling		0.7	

When the diodes 1 and 2 are used simultaneously:

 ΔT_j (diode 1) = P(diode1) x R_{th(j-c)}(Per diode) + P(diode 2) x R_{th(c)}

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
ı (1)	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}			200	μA
'R `´		T _j = 125 °C	$\nabla R = \nabla RRM$		45	60	mA
	$T_{j} = 25 \text{ °C}$ $T_{j} = 125 \text{ °C}$ $T_{j} = 25 \text{ °C}$ $T_{j} = 25 \text{ °C}$			0.62			
		T _j = 125 °C	$-1_{\rm F} = 7.5 {\rm A}$		0.52	0.57	
V _F ⁽¹⁾		T _j = 25 °C	1 10 1			0.76	V
۷F、	Forward voltage drop	T _j = 125 °C	– I _F = 12 A		0.62	0.68	v
		T _j = 25 °C	— I _F = 15 A			0.82	
		T _j = 125 °C			0.66	0.72	

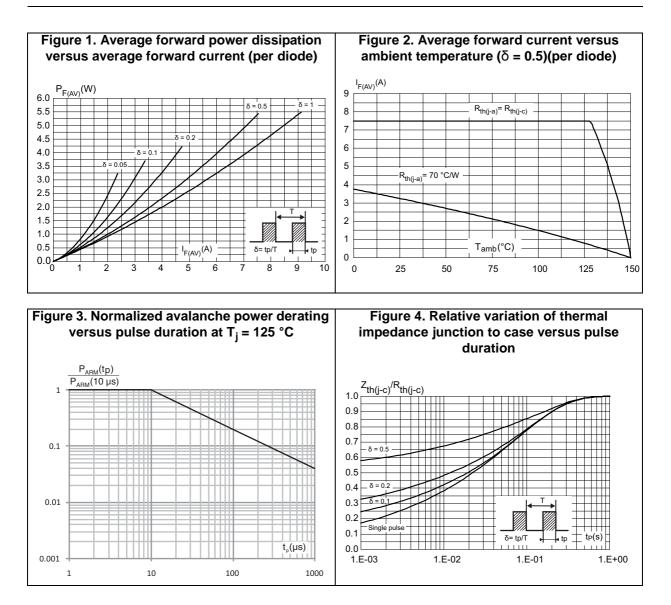
Table 4. Static electrical characteristics (per diode)

1. Pulse test: t_p = 380 µs, δ < 2%

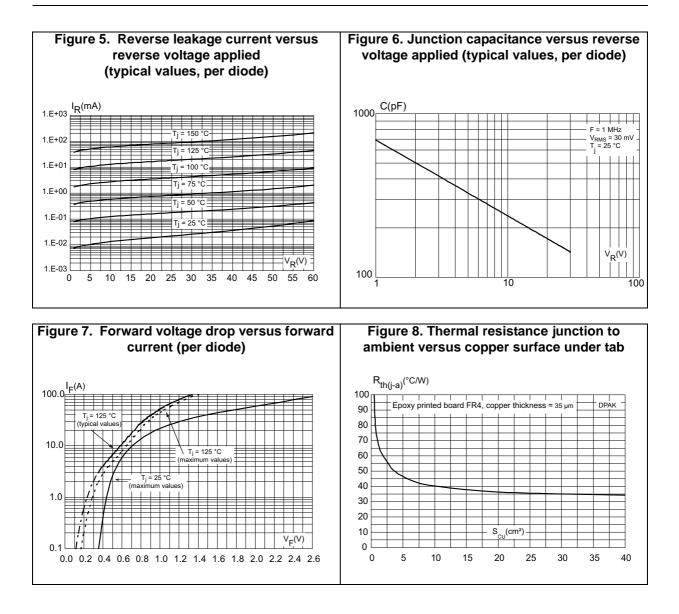
To evaluate the conduction losses use the following equation:

 $P = 0.32 \text{ x } I_{F(AV)} + 0.027 I_{F}^{2}(RMS)$











2 Package Information

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

2.1 DPAK package information

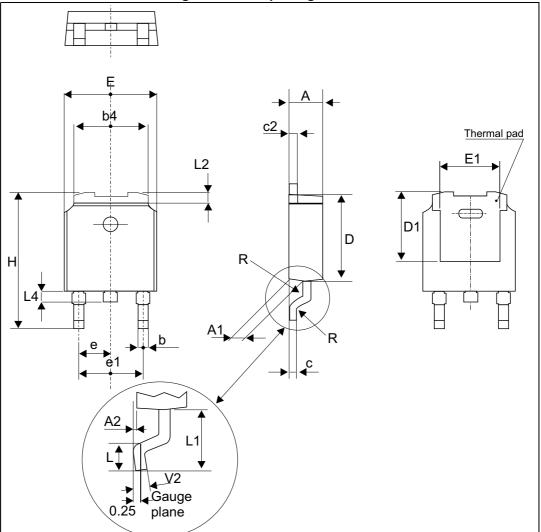


Figure 9. DPAK package outline

Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.



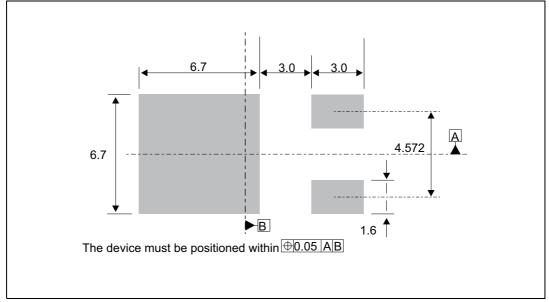
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	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	2.18		2.40	0.085		0.094	
A1	0.90		1.10	0.035		0.043	
A2	0.03		0.23	0.001		0.009	
b	0.64		0.90	0.025		0.035	
b4	4.95		5.46	0.194		0.214	
С	0.46		0.61	0.018		0.024	
c2	0.46		0.60	0.018		0.023	
D	5.97		6.22	0.235		0.244	
D1	4.95		5.60	0.194		0.220	
E	6.35		6.73	0.250		0.264	
E1	4.32		5.50	0.170		0.216	
е		2.28			0.090		
e1	4.40		4.70	0.173		0.185	
Н	9.35		10.40	0.368		0.409	
L	1.00		1.78	0.039		0.070	
L2			1.27			0.050	
L4	0.60		1.02	0.023		0.040	
V2	-8°		+8°	-8°		8°	

Table 5. DPAK package mechanical data





3 Ordering Information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS15L60CB	S15L60C	DPAK	0.32 g	75	Tube
STPS15L60CB-TR	S15L60C	DPAK	0.32 g	2500	Tape and reel

4 Revision history

Date	Revision	Description of Changes
27-Jun-2012	2	Automatic revalidation date workflow started.
07-Jan-2015	3	Updated DPAK package information and reformatted to current standard.
18-Dec-2015	4	Updated DPAK package information and reformatted to current standard.

Table 7. Document revision history



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